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# HCMA0703

## Automotive grade High current power inductors



### Description

- Automotive grade 3 qualified
- High current carrying capacity, low core losses
- Magnetically shielded, low EMI
- Frequency range up to 5 MHz
- Inductance range from 0.15  $\mu\text{H}$  to 33  $\mu\text{H}$
- Current range from 1.8 A to 52 A
- 7.4 mm x 7.0 mm footprint surface mount package in a 3.0 mm height
- Iron powder core material
- Halogen free, lead free, RoHS compliant

### Applications

- Body electronics
  - Central body control module
  - Vehicle access control system
  - Headlamps, tail lamps and interior lighting
  - Heating ventilation and air conditioning controllers (HVAC)
  - Doors, window lift and seat control
- Advanced driver assistance systems
  - 77 GHz radar systems
  - Adaptive cruise control (ACC)
  - Automatic parking control
  - Collision avoidance system
  - Car black box system
- Infotainment and cluster electronics
  - Active noise cancellation (ANC)
  - Audio subsystem: head unit and trunk amp
  - Digital instrument cluster
  - In-vehicle infotainment (IVI) and navigation
  - Port power/USB HUB for front and rear passengers
- Chassis and safety electronics
  - Airbag control unit
  - Electronic Stability Control System (ESC)

### Environmental Data

- Storage temperature range (Component): -55 °C to +125 °C
- Operating temperature range: -55 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020D compliant



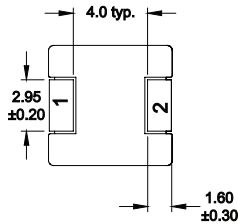
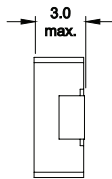
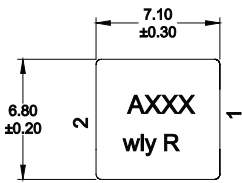
Product Specifications

Part Number <sup>6</sup>	OCL <sup>1</sup> ( $\mu\text{H}$ ) $\pm 20\%$	FLL <sup>2</sup> ( $\mu\text{H}$ ) minimum	$I_{\text{rms}}$ <sup>3</sup> (A)	$I_{\text{sat}}$ <sup>4</sup> (A)	DCR (m $\Omega$ ) typical @ 20 °C	DCR (m $\Omega$ ) maximum @ 20 °C	K-factor <sup>5</sup>
HCMA0703-R15-R	0.15	0.09	26	52	1.9	2.5	1044
HCMA0703-R22-R	0.22	0.13	23	40	2.5	2.8	986
HCMA0703-R47-R	0.47	0.28	17.5	26	4.0	4.2	580
HCMA0703-R68-R	0.68	0.41	15.5	25	5.0	5.5	455
HCMA0703-R82-R	0.82	0.49	13	24	6.7	8.0	439
HCMA0703-1R0-R	1.0	0.60	11	22	9.0	10	374
HCMA0703-1R5-R	1.5	0.90	9.0	18	14	15	366
HCMA0703-2R2-R	2.2	1.32	8.0	14	18	20	281
HCMA0703-3R3-R	3.3	1.98	6.0	13.5	28	30	252
HCMA0703-4R7-R	4.7	2.82	5.5	10	37	40	210
HCMA0703-6R8-R	6.8	4.08	4.5	8.0	54	60	151
HCMA0703-8R2-R	8.2	4.92	4.0	7.5	64	68	142
HCMA0703-100-R	10	6.00	3.2	7.0	71	78	132
HCMA0703-220-R	22	14.1	2.3	3.0	135	149	83
HCMA0703-330-R	33	19.8	1.8	2.2	220	242	76

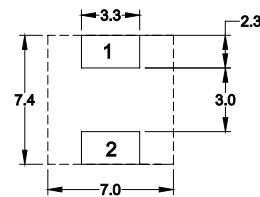
- Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.25 Vrms, 0.0 Adc, +25 °C
- Full Load Inductance (FLL) Test Parameters: 100 kHz, 0.25 Vrms, Isat, +25 °C
- $I_{\text{rms}}$ : DC current for an approximate temperature rise of 40 °C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125 °C under worst case operating conditions verified in the end application.

- $I_{\text{sat}}$ : Peak current for approximately 20% rolloff @ +25 °C
- K-factor: Used to determine Bp-p for core loss (see graph).  $Bp-p = K * L * \Delta I$ . Bp-p: (Gauss), K: (K-factor from table), L: (Inductance in  $\mu\text{H}$ ),  $\Delta I$  (Peak to peak ripple current in Amps).
- Part Number Definition: HCMA0703-xxx-R  
 HCMA0703 = Product code and size  
 -xxx= inductance value in  $\mu\text{H}$ , R= decimal point,  
 If no R is present then last character equals number of zeros  
 -R suffix = RoHS compliant

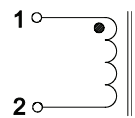
Dimensions (mm)



Recommended Pad Layout



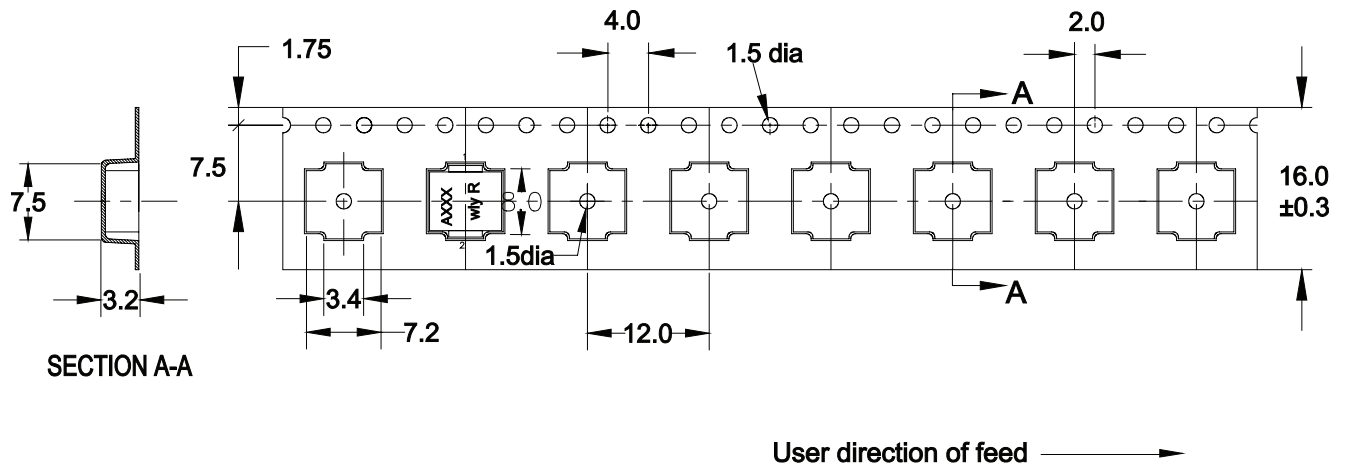
Schematic



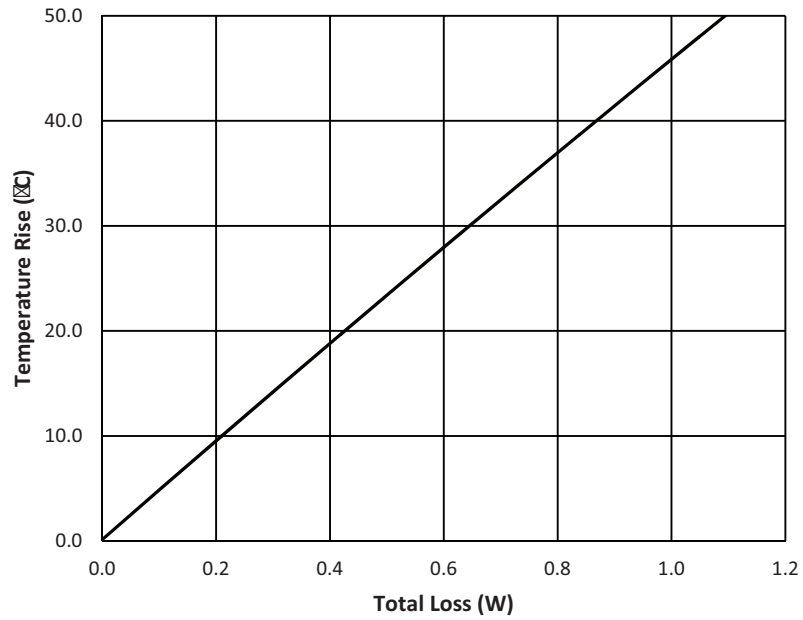
Part marking: A= Automotive grade, xxx= inductance value in  $\mu\text{H}$ , R= decimal point. If no R is present then last character equals number of zeros  
 wly= date code, R=revision level  
 All soldering surfaces to be coplanar within 0.1 millimeters.  
 Tolerances are  $\pm 0.3$  millimeters unless stated otherwise.  
 Color: Grey  
 Do not route traces or vias underneath the inductor

**Packaging information (mm)**

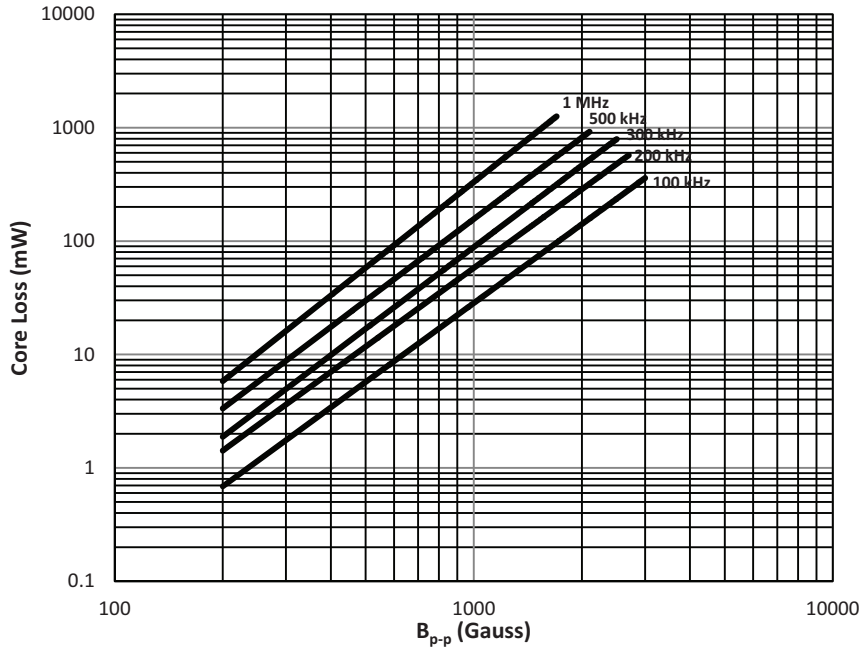
Supplied in tape and reel packaging , 1500 parts per 13" diameter reel



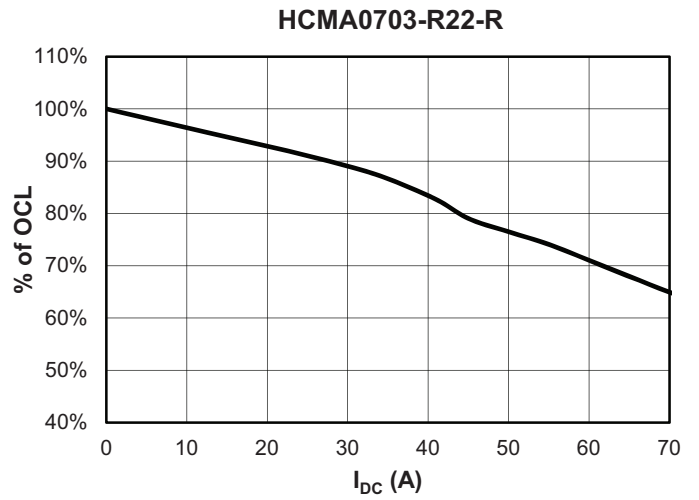
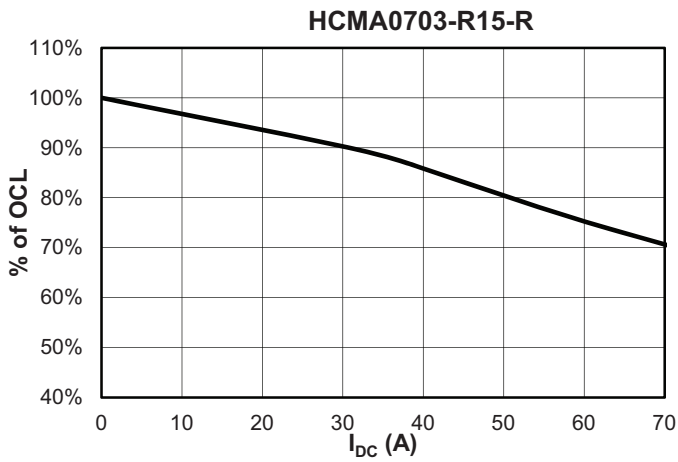
**Temperature rise vs. total loss**



Core loss vs.  $B_{p-p}$

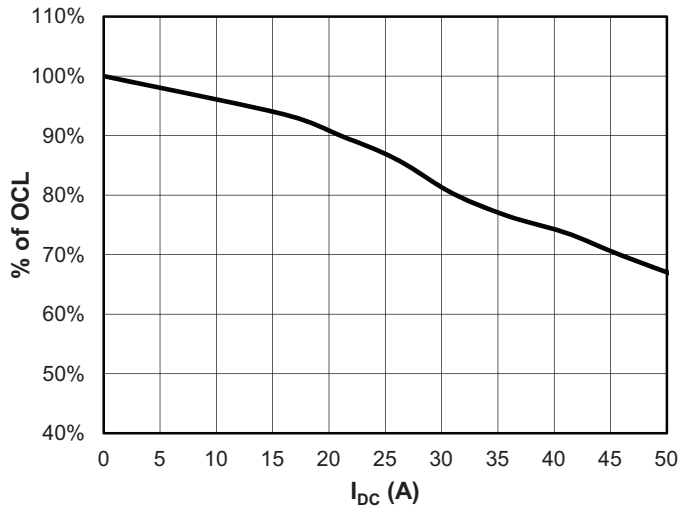


Inductance characteristics

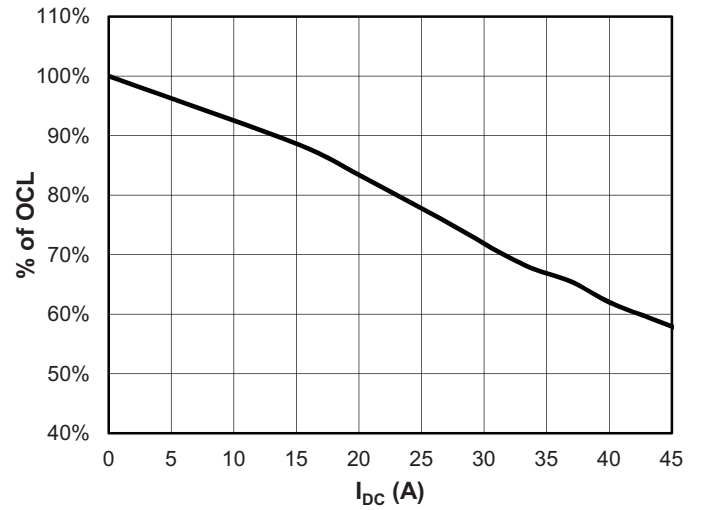


Inductance characteristics

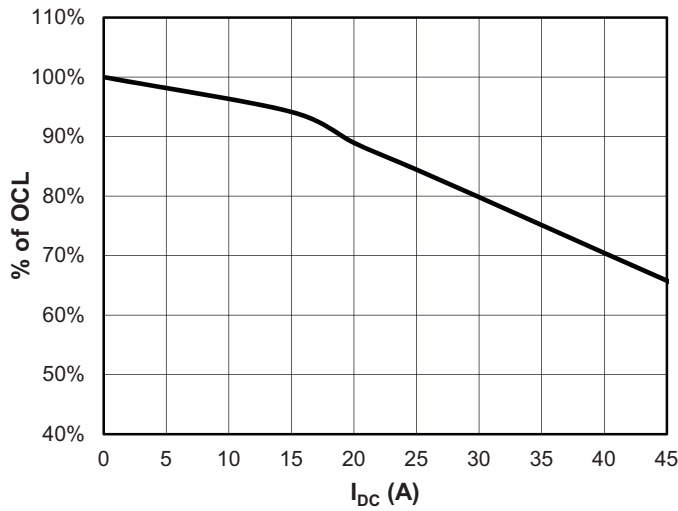
HCMA0703-R47-R



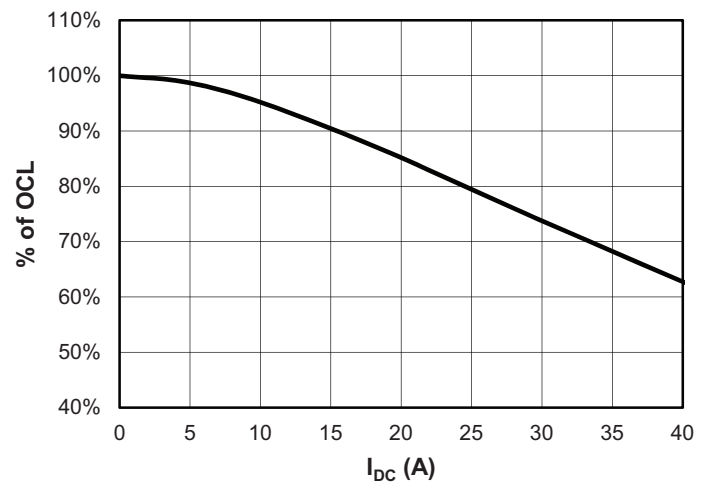
HCMA0703-R68-R



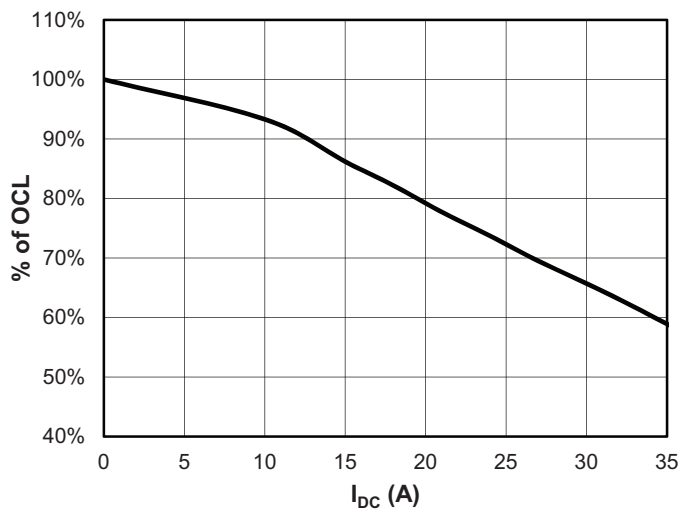
HCMA0703-R82-R



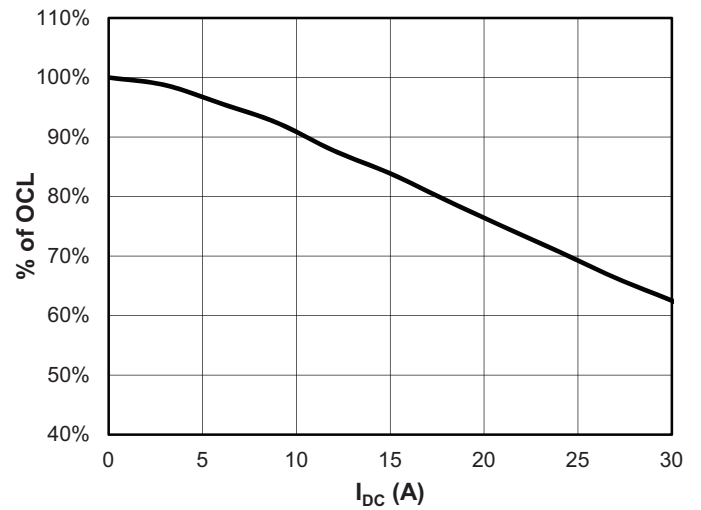
HCMA0703-1R0-R



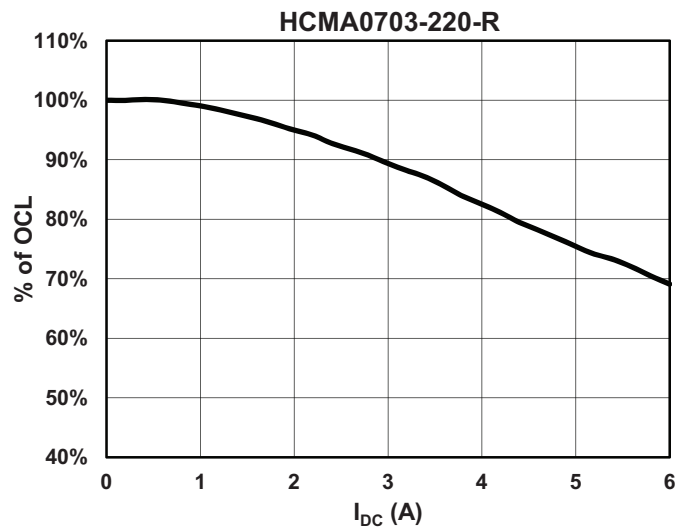
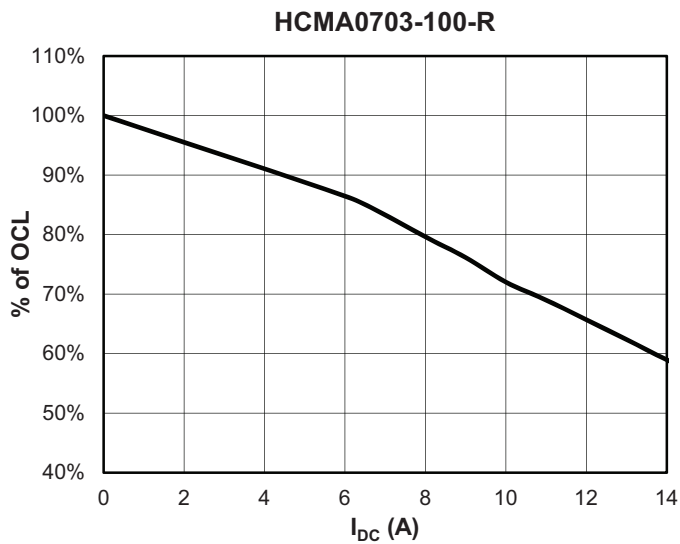
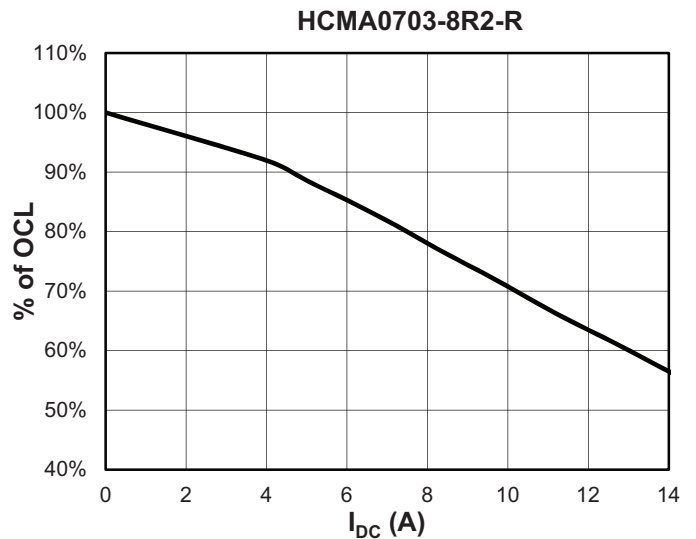
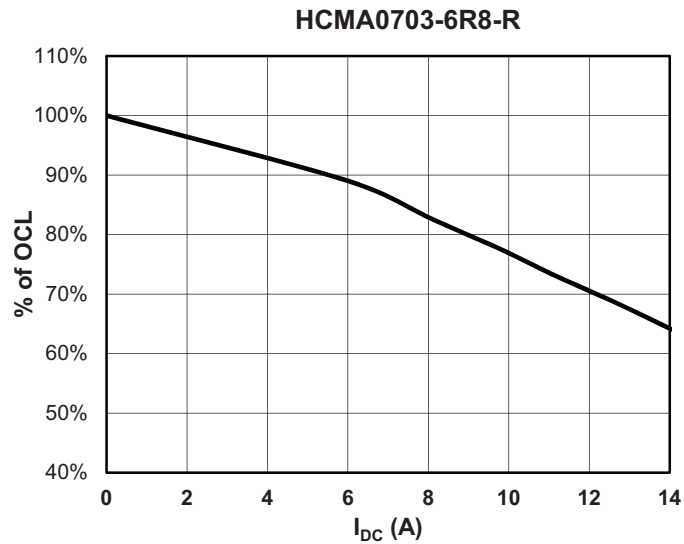
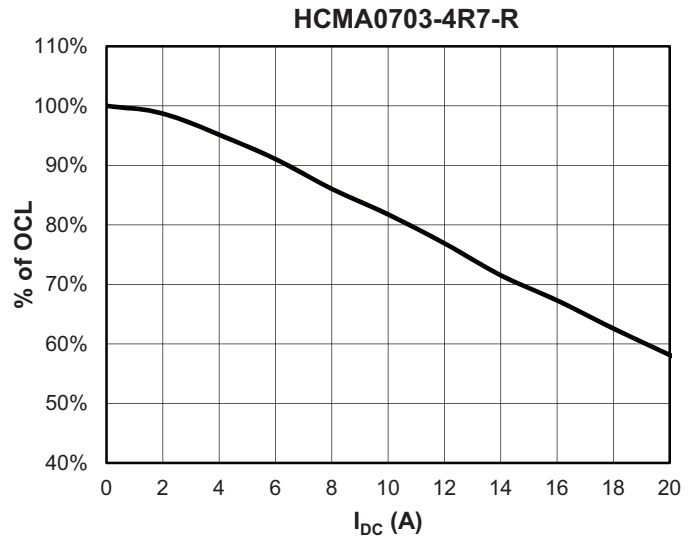
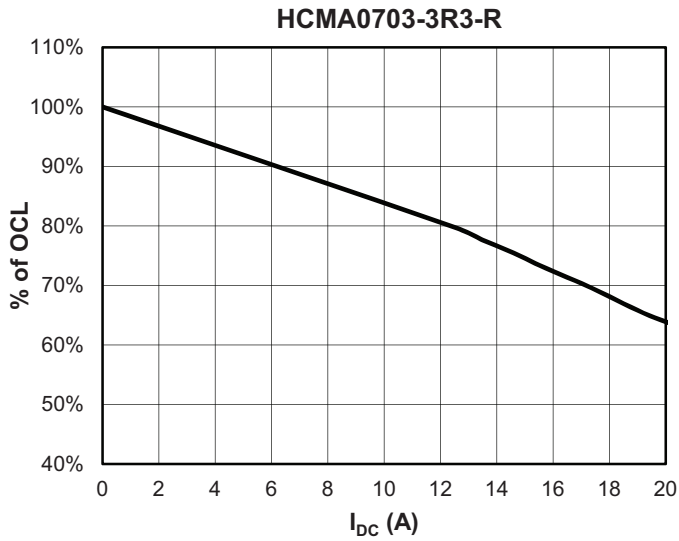
HCMA0703-1R5-R



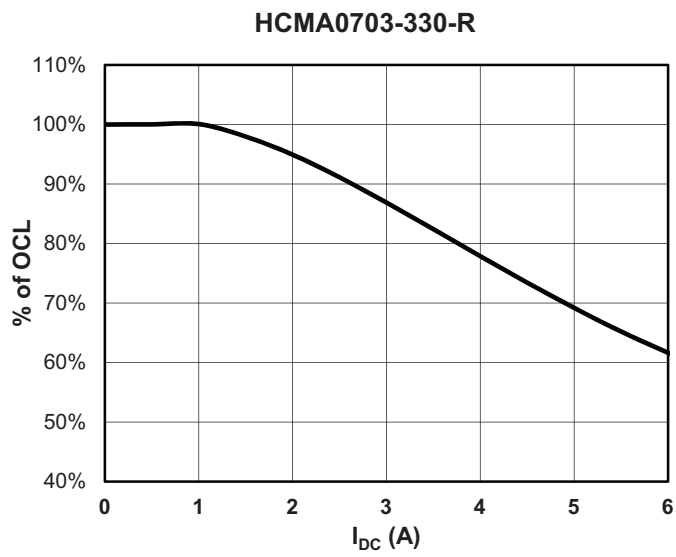
HCMA0703-2R2-R



Inductance characteristics

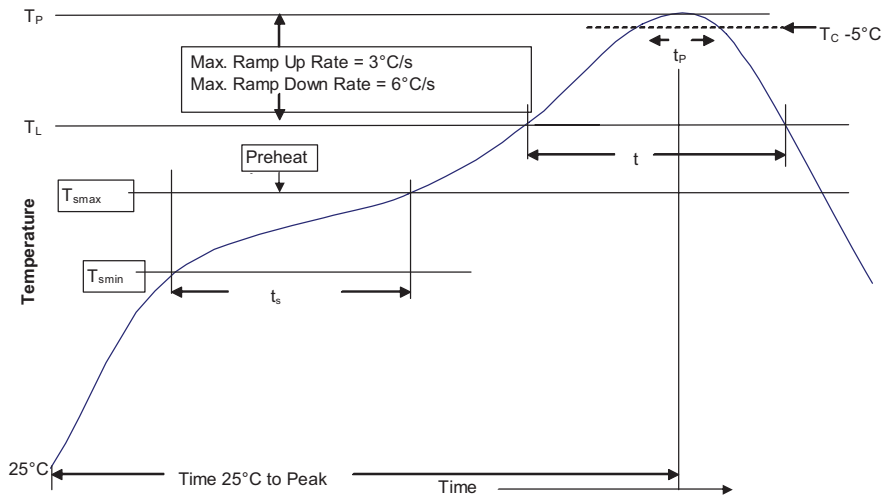


Inductance characteristics





**Solder reflow profile**



**Table 1 - Standard SnPb Solder ( $T_c$ )**

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

**Table 2 - Lead (Pb) Free Solder ( $T_c$ )**

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350 - 2000	Volume mm <sup>3</sup> >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

**Reference JDEC J-STD-020D**

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder
Preheat and Soak		
• Temperature min. ( $T_{smin}$ )	100°C	150°C
• Temperature max. ( $T_{smax}$ )	150°C	200°C
• Time ( $T_{smin}$ to $T_{smax}$ ) ( $t_s$ )	60-120 Seconds	60-120 Seconds
Average ramp up rate $T_{smax}$ to $T_p$	3°C/ Second Max.	3°C/ Second Max.
Liquidous temperature ( $T_L$ )	183°C	217°C
Time at liquidous ( $t_L$ )	60-150 Seconds	60-150 Seconds
Peak package body temperature ( $T_p$ )*	Table 1	Table 2
Time ( $t_p$ )** within 5 °C of the specified classification temperature ( $T_c$ )	20 Seconds**	30 Seconds**
Average ramp-down rate ( $T_p$ to $T_{smax}$ )	6°C/ Second Max.	6°C/ Second Max.
Time 25°C to Peak Temperature	6 Minutes Max.	8 Minutes Max.

\* Tolerance for peak profile temperature ( $T_p$ ) is defined as a supplier minimum and a user maximum.

\*\* Tolerance for time at peak profile temperature ( $t_p$ ) is defined as a supplier minimum and a user maximum.

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